

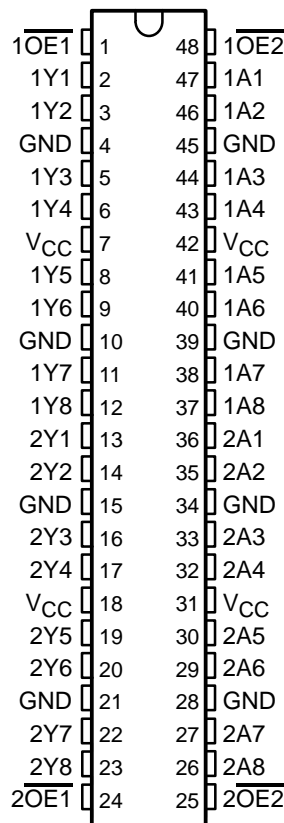
# SN74LVCH16541A

## 16-BIT BUFFER/DRIVER WITH 3-STATE OUTPUTS

SCAS567D – MARCH 1996 – REVISED JUNE 1997

- Member of the Texas Instruments *Widebus™* Family
- *EPIC™* (Enhanced-Performance Implanted CMOS) Submicron Process
- Typical  $V_{OLP}$  (Output Ground Bounce)  $< 0.8$  V at  $V_{CC} = 3.3$  V,  $T_A = 25^\circ\text{C}$
- Typical  $V_{OHV}$  (Output  $V_{OH}$  Undershoot)  $> 2$  V at  $V_{CC} = 3.3$  V,  $T_A = 25^\circ\text{C}$
- Power Off Disables Inputs/Outputs, Permitting Live Insertion
- Supports Mixed-Mode Signal Operation on All Ports (5-V Input/Output Voltage With 3.3-V  $V_{CC}$ )
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model ( $C = 200$  pF,  $R = 0$ )
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors
- Package Options Include Thin-Shrink Small-Outline (DGG) and Plastic 300-mil Shrink Small-Outline (DL) Packages

DGG OR DL PACKAGE  
(TOP VIEW)



### description

This 16-bit buffer/driver is designed for 2.7-V to 3.6-V  $V_{CC}$  operation.

The SN74LVCH16541A is a noninverting 16-bit buffer composed of two 8-bit sections with separate output-enable signals. For either 8-bit buffer section, the two output-enable ( $1\overline{OE}1$  and  $1\overline{OE}2$  or  $2\overline{OE}1$  and  $2\overline{OE}2$ ) inputs must be low for the corresponding Y outputs to be active. If either output-enable input is high, the outputs of that 8-bit buffer section are in the high-impedance state.

To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

Inputs can be driven from either 3.3-V or 5-V devices. This feature allows the use of these devices as translators in a mixed 3.3-V/5-V system environment.

Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level.

The SN74LVCH16541A is characterized for operation from  $-40^\circ\text{C}$  to  $85^\circ\text{C}$ .



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 **TEXAS  
INSTRUMENTS**

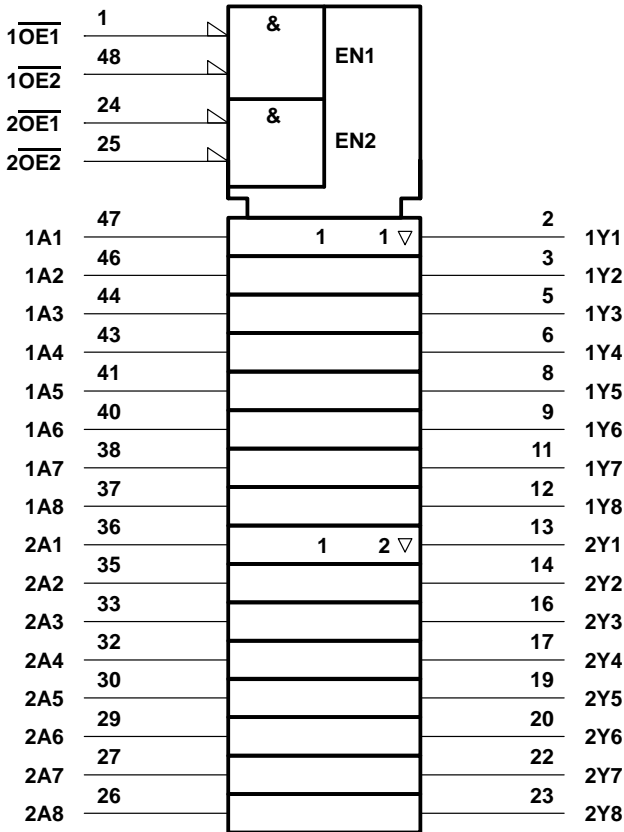
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FUNCTION TABLE  
(each 8-bit section)

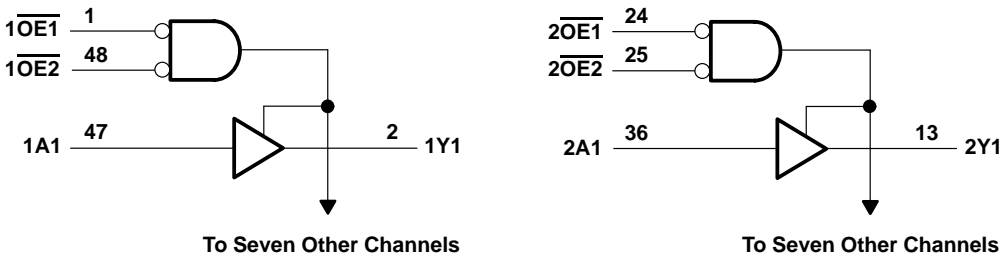
INPUTS			OUTPUT Y
OE1	OE2	A	
L	L	L	L
L	L	H	H
H	X	X	Z
X	H	X	Z

logic symbol†



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)



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**16-BIT BUFFER/DRIVER**  
**WITH 3-STATE OUTPUTS**

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**absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†**

Supply voltage range, $V_{CC}$	–0.5 V to 6.5 V
Input voltage range, $V_I$ (see Note 1)	–0.5 V to 6.5 V
Voltage range applied to any output in the high-impedance or power-off state, $V_O$ (see Note 1)	–0.5 V to 6.5 V
Voltage range applied to any output in the high or low state, $V_O$ (see Notes 1 and 2)	–0.5 V to $V_{CC} + 0.5$ V
Input clamp current, $I_{IK}$ ( $V_I < 0$ )	–50 mA
Output clamp current, $I_{OK}$ ( $V_O < 0$ or $V_O > V_{CC}$ )	±50 mA
Continuous output current, $I_O$ ( $V_O = 0$ to $V_{CC}$ ) (see Note 2)	±50 mA
Continuous current through $V_{CC}$ or GND	±100 mA
Package thermal impedance, $\theta_{JA}$ (see Note 3): DGG package	89°C/W
DL package	94°C/W
Storage temperature range, $T_{stg}$	–65°C to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.  
2. The value of  $V_{CC}$  is provided in the recommended operating conditions table.  
3. The package thermal impedance is calculated in accordance with JESD 51.

**recommended operating conditions (see Note 4)**

		MIN	MAX	UNIT
$V_{CC}$ Supply voltage	Operating	2	3.6	V
	Data retention only	1.5		
$V_{IH}$ High-level input voltage	$V_{CC} = 2.7$ V to 3.6 V	2		V
$V_{IL}$ Low-level input voltage	$V_{CC} = 2.7$ V to 3.6 V		0.8	V
$V_I$ Input voltage		0	5.5	V
$V_O$ Output voltage	High or low state	0	$V_{CC}$	V
	3 state	0	5.5	
$I_{OH}$ High-level output current	$V_{CC} = 2.7$ V		–12	mA
	$V_{CC} = 3$ V		–24	
$I_{OL}$ Low-level output current	$V_{CC} = 2.7$ V		12	mA
	$V_{CC} = 3$ V		24	
$\Delta t/\Delta v$ Input transition rise or fall rate		0	10	ns/V
$T_A$ Operating free-air temperature		–40	85	°C

NOTE 4: Unused control inputs must be held high or low to prevent them from floating.



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## 16-BIT BUFFER/DRIVER

### WITH 3-STATE OUTPUTS

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**electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)**

PARAMETER	TEST CONDITIONS	V <sub>CC</sub>	MIN	TYP†	MAX	UNIT
V <sub>OH</sub>	I <sub>OH</sub> = –100 µA	2.7 V to 3.6 V	V <sub>CC</sub> –0.2			V
	I <sub>OH</sub> = –12 mA	2.7 V	2.2			
		3 V	2.4			
	I <sub>OH</sub> = –24 mA	3 V	2.2			
V <sub>OL</sub>	I <sub>OL</sub> = 100 µA	2.7 V to 3.6 V			0.2	V
	I <sub>OL</sub> = 12 mA	2.7 V			0.4	
	I <sub>OL</sub> = 24 mA	3 V			0.55	
I <sub>I</sub>	V <sub>I</sub> = 0 to 5.5 V	3.6 V			±5	µA
I <sub>I</sub> (hold)	V <sub>I</sub> = 0.8 V	3 V	75			µA
	V <sub>I</sub> = 2 V	3 V	–75			
	V <sub>I</sub> = 0 to 3.6 V‡	3.6 V			±500	
I <sub>off</sub>	V <sub>I</sub> or V <sub>O</sub> = 5.5 V	0			±10	µA
I <sub>OZ</sub>	V <sub>O</sub> = 0 to 5.5 V	3.6 V			±10	µA
I <sub>CC</sub>	V <sub>I</sub> = V <sub>CC</sub> or GND	3.6 V	I <sub>O</sub> = 0		20	µA
	3.6 V ≤ V <sub>I</sub> ≤ 5.5 V§				20	
ΔI <sub>CC</sub>	One input at V <sub>CC</sub> – 0.6 V, Other inputs at V <sub>CC</sub> or GND	2.7 V to 3.6 V			500	µA
C <sub>i</sub>	V <sub>I</sub> = V <sub>CC</sub> or GND	3.3 V		5		pF
C <sub>o</sub>	V <sub>O</sub> = V <sub>CC</sub> or GND	3.3 V		6.5		pF

† All typical values are at V<sub>CC</sub> = 3.3 V, T<sub>A</sub> = 25°C.

‡ This is the bus-hold maximum dynamic current required to switch the input from one state to another.

§ This applies in the disabled state only.

**switching characteristics over recommended operating free-air temperature range, C<sub>L</sub> = 50 pF (unless otherwise noted) (see Figure 1)**

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V <sub>CC</sub> = 3.3 V ± 0.3 V		V <sub>CC</sub> = 2.7 V		UNIT
			MIN	MAX	MIN	MAX	
t <sub>pd</sub>	A	Y	1.1	4.2		5	ns
t <sub>en</sub>	$\overline{OE}$	Y	1.5	5.6		6.9	ns
t <sub>dis</sub>	$\overline{OE}$	Y	1.9	6.8		7.4	ns
t <sub>sk(o)</sub> ¶				1.3			ns

¶ Skew between any two outputs of the same package switching in the same direction. This parameter is warranted but not production tested.

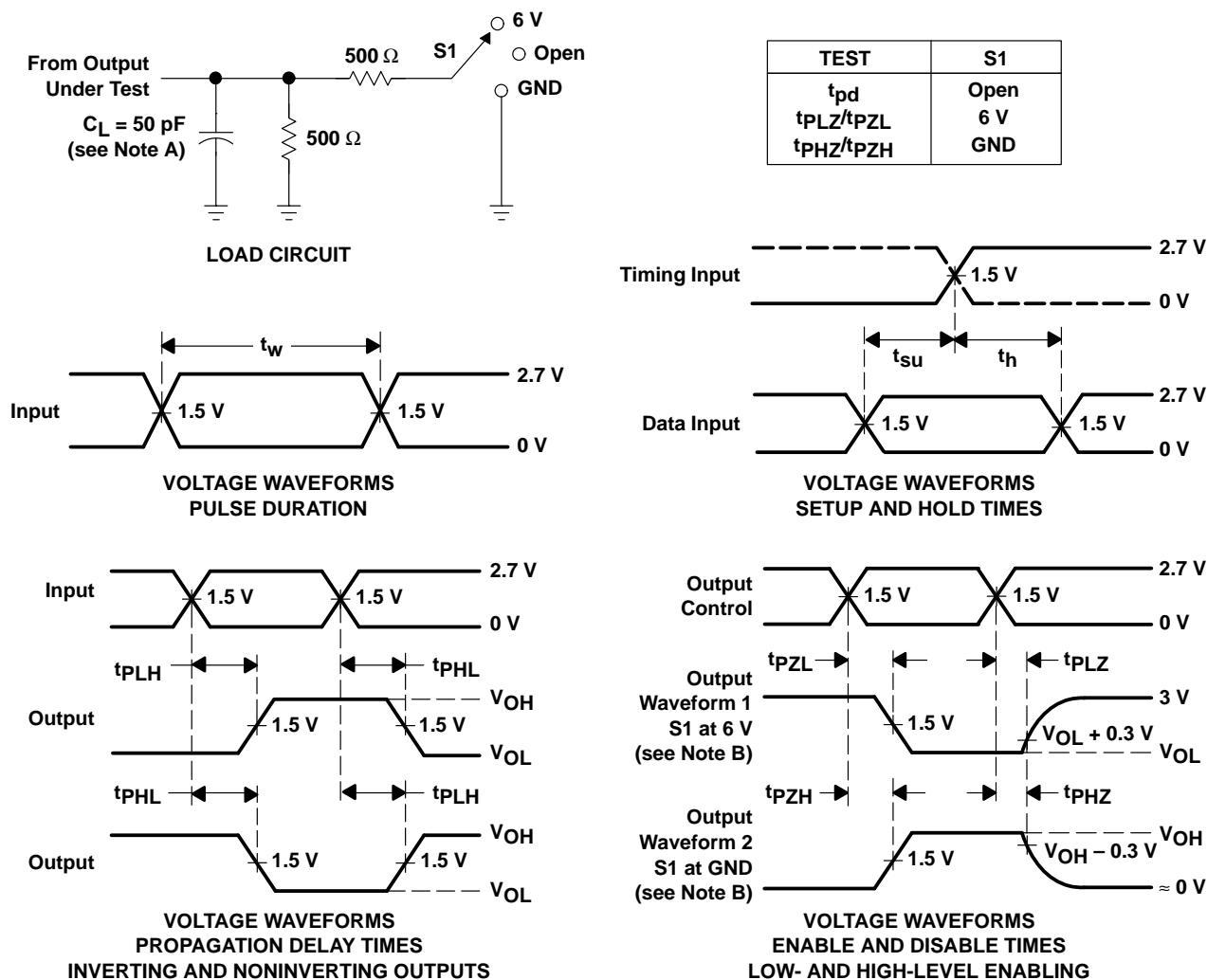
**operating characteristics, V<sub>CC</sub> = 3.3 V, T<sub>A</sub> = 25°C**

PARAMETER		TEST CONDITIONS	TYP	UNIT
C <sub>pd</sub>	Power dissipation capacitance per buffer/driver	C <sub>L</sub> = 0, f = 10 MHz	35	pF
	Outputs enabled Outputs disabled		4	



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## PARAMETER MEASUREMENT INFORMATION



- NOTES:
- $C_L$  includes probe and jig capacitance.
  - Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
  - All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10$  MHz,  $Z_O = 50 \Omega$ ,  $t_r \leq 2.5$  ns,  $t_f \leq 2.5$  ns.
  - The outputs are measured one at a time with one transition per measurement.
  - $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
  - $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
  - $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .

Figure 1. Load Circuit and Voltage Waveforms

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